

C0603X519C2TACTU

Aliases (C0603X519C2TAC7867) SMD Comm X8G HT150C Flex, Ceramic, 5.1 pF, +/-0.25 pF, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

	Specifications		
503	Capacitance	5.1 pF	
mm +/-0.17mm	Measurement Condition	1 MHz 1.0Vrms	
8mm +/-0.15mm	Tolerance	+/-0.25 pF	
8mm +/-0.15mm	Voltage DC	200 VDC	
4mm MIN	Dielectric Withstanding Voltage	500 VDC	
45mm +/-0.15mm	Temperature Range	-55/+150°C	
	Temp. Coefficient	X8G	
	Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms	
R, 180mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)		
000	Dissipation Factor	0.1% 1 MHz 1.0Vrms	

Aging Rate

Insulation Resistance

 Dimensions

 Chip Size
 0603

 L
 1.6mm +/-0.17mm

 W
 0.8mm +/-0.15mm

 T
 0.8mm +/-0.15mm

 S
 0.4mm MIN

 B
 0.45mm +/-0.15mm

Packaging Specifications

Packaging Quantity 4000	

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0% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms